

WORKSHOP



EU – South Korea Joint Researchers Forum on Semiconductors

The Future of Semiconductors

Neuromorphic Computing, Advanced Functionalities, Heterogeneous Integration & Packaging

PRELIMINARY PROGRAMME

1 st DAY
Morning
Coffee and Pastries 8h30
9h00 OPENING AND POLICY SESSION
 Introduction Werner Steinhoegl, Head of Sector CONNECT.A3/Francis Balestra, ICOS coordinator 9h05 Welcome note – Republic of Korea Mr Jong-Ho Lee, Minister of MSIT 9h15 Welcome note – European Commission Mrs Lucilla Sioli, Director CONNECT.A 9h25 International Cooperation in the Chips Joint Undertaking Mr Jari Kinaret, Director Chips JU 9h35 International Collaboration Programs of Korea in Semiconductor R&D Dr. Sang-Wan Ryu, Director of NRF (National Research Foundation of Korea) 9h50 Presentation of EU-ROK Joint Call Yves Gigase, Head of programmes Chips JU
Coffee break 10h05
10h35SESSION 1 – Advanced Functionalities / Heterogeneous Integration &Packaging
 Electrochemical Calculations and Microstructural Analysis in Copper Electroplating to Fill Patterns at Various Feature Scales Hyojong Lee, Professor of Dong-A University Specialized microelectronics for in-memory computing, RF communication and quantum Jyrki Kiihamäki, VTT Integrated Photonics: Enabling the Progression of Digital Society Abdul Rahim, Photon Delta Digital technologies for Agri 4.0 applications Alan O'Riordan, Tyndall Silicon Carbide Electronics for Advanced Power, Sensing and System Integration Michael Jank, Fraunhofer IISB
Lunch Break & Posters 12h40
Afternoon SESSION 2 – Advanced logic and memories / Neuromorphic computing
 Innovative materials and devices for future logic and memory technologies Sujin Ahn, Vice President of Samsung Electronics Research on FD-SOI and non-volatile memory Olivier Faynot, CEA-LETI PIM use case - Cost effective LLM accelerator using AiM (SK hynix's PIM) Euicheol Lim, Vice President of SK Hynix Enabling new research paths with embedded PCM Andrea Redaelli, STMicroelectronics AI Semiconductor (On-Device AI) Present and Future Hoijun Yoo, Professor of KAIST (Korea Advanced Institute of Science and Technology) Emerging ferroelectric materials and devices for semiconductor applications Minhyuk Park, Dreference of Science Intervention
Professor of Seoul National University Coffee break & Posters 16h15



2D Materials for Neuromorphic Computing Jimin Lee, RWTH Aachen University

Lunch & posters 12h

POSTERS SESSION

- Powering the Future: High-Energy Efficiency Nanoelectronics for Advanced Neuromorphic Computing *Qing-Tai Zhao, Forschungszentrum Jülich*
- MoS2 growth and device technology; towards integration with multiplexed graphene sensors arrays Laura Remacha Gelabertó, Institut Català de Nanociència i Nanotecnologia
- **Neuromorphic Computing: Latest activities at ELD and AMO** Jan van den Hurk RWTH, Aachen University
- Smart Sensors and Systems as Enabling Technologies for Climate-Smart Agriculture Danilo Demarchi, Politecnico di Torino
- Patterned Multi-Wall Nanosheet FETs for Aggressive Scaling Beyond Forksheet FETs: Zero Gate Extension with Minimal Gate Cut Width Sanguk Lee, POSTECH
- Heterogenous integration of TMD-based memristors and memtransistors with Si CMOS for neuromorphic computing *Francisco Gamiz*, University of Granada
- Encapsulation and protection strategies for graphene-based solution-gated field-effect transistors towards high performing neural recording *Anna Graf, ICN2*
- Metal oxide-based structures for novel computing paradigm concepts *Robert Mroczyński*, *Warsaw University of Technology*
- Advancements in Neuromorphic Computing Using Silicon Nitride Memristors for IoT and Security Panagiotis Dimitrakis, NCSR Demokritos
- High Performance Chiplet-based PIM AI Semiconductor Jaehoon Chung / Jaewoong Choi, ETRI
- Smart systems integration for biomedical and environmental applications *Bogdan Firtat, IMT* Bucharest
- Advanced computing and functionalities in CROMA lab Alessandro Cresti, CNRS
- Full-Stack Neuromorphic Computing in Delft Moritz Fieback, TUDelft
- Neuromorphic sensing and computing at INL Bruno Romeira, INL